

Title (en)  
MOLD BASE FOR THERMOPLASTIC CONTAINER MANUFACTURING MOLD, AND MOLDING DEVICE EQUIPPED WITH SAME

Title (de)  
FORMBODEN FÜR EINE FORM ZUR HERSTELLUNG EINES THERMOPLASTISCHEN BEHÄLTERS UND FORMVORRICHTUNG DAMIT

Title (fr)  
FOND DE MOULE POUR MOULE DE FABRICATION DE RECIPIENTS THERMOPLASTIQUES, ET DISPOSITIF DE MOULAGE EQUIPE D'AU MOINS UN MOULE POURVU D'UN TEL FOND

Publication  
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Application  
**EP 07730965 A 20070213**

Priority  
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• FR 0601482 A 20060220

Abstract (en)  
[origin: FR2897554A1] The mould base (1) has a series of radial ridges (13) with curved concave crests (14) extending outwards from the centre of the mould cavity (C), with the recesses between the ridges made with flat central zones (18) lying in a plane perpendicular to the mould base axis (12). Each recess has an outer cavity (11) in the shape of a circular arc that extends radially for a distance similar to that of the central zone, and each cavity is linked to a central zone by a curved surface (19) with a radius similar to that of the cavity. The diameter (D) of a circle connecting the central points of the cavities is about 2.8 or 2.7 times the radius (R) of the flat central zone.

IPC 8 full level  
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